

### 3.2x2.4mm SMD CHIP LED LAMP

PRELIMINARY SPEC



**ATTENTION** OBSERVE PRECAUTIONS FOR HANDLING **ELECTROSTATIC** DISCHARGE SENSITIVE **DEVICES** 

Part Number: APD3224ZGC/G-F01 Green

#### **Features**

- 3.2x2.4mm SMT LED, 2.4mm thickness.
- Low power consumption.
- Ideal for backlight and indicator.
- Various colors and lens types available.
- Package : 1500pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

### Description

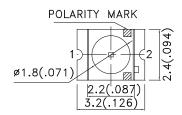
The Green source color devices are made with InGaN Light Emitting Diode.

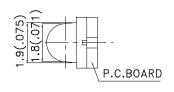
Static electricity and surge damage the LEDS.

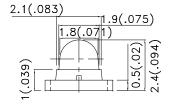
It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

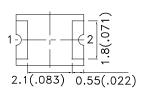
All devices, equipment and machinery must be electrically grounded.

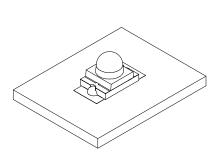
## **Package Dimensions**











- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.1 (0.004")$  unless otherwise noted.
- 3. Specifications are subject to change without notice.4. The device has a single mounting surface. The device must be mounted according to the specifications.





SPEC NO: DSAJ8736 **REV NO: V.1** DATE: OCT/21/2009 PAGE: 1 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: M.L.Xu ERP: 1203009978

### **Selection Guide**

| Part No.         | Dice          | Lens Type   | lv (mcd) [2]<br>@ 20mA |      | Viewing<br>Angle [1] |
|------------------|---------------|-------------|------------------------|------|----------------------|
|                  |               | 2.          | Min.                   | Тур. | 201/2                |
| APD3224ZGC/G-F01 | Green (InGaN) | WATER CLEAR | 3300                   | 5300 | 20°                  |

- 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value. 2. Luminous intensity/ luminous Flux: +/-15%.

## Electrical / Optical Characteristics at TA=25°C

| Symbol | Parameter                | Device | Тур. | Max. | Units | Test Conditions    |
|--------|--------------------------|--------|------|------|-------|--------------------|
| λpeak  | Peak Wavelength          | Green  | 520  |      | nm    | IF=20mA            |
| λD [1] | Dominant Wavelength      | Green  | 525  |      | nm    | IF=20mA            |
| Δλ1/2  | Spectral Line Half-width | Green  | 35   |      | nm    | IF=20mA            |
| С      | Capacitance              | Green  | 100  |      | pF    | VF=0V;f=1MHz       |
| VF [2] | Forward Voltage          | Green  | 3.2  | 4    | V     | IF=20mA            |
| lr     | Reverse Current          | Green  |      | 10   | uA    | V <sub>R</sub> =5V |

## Notes:

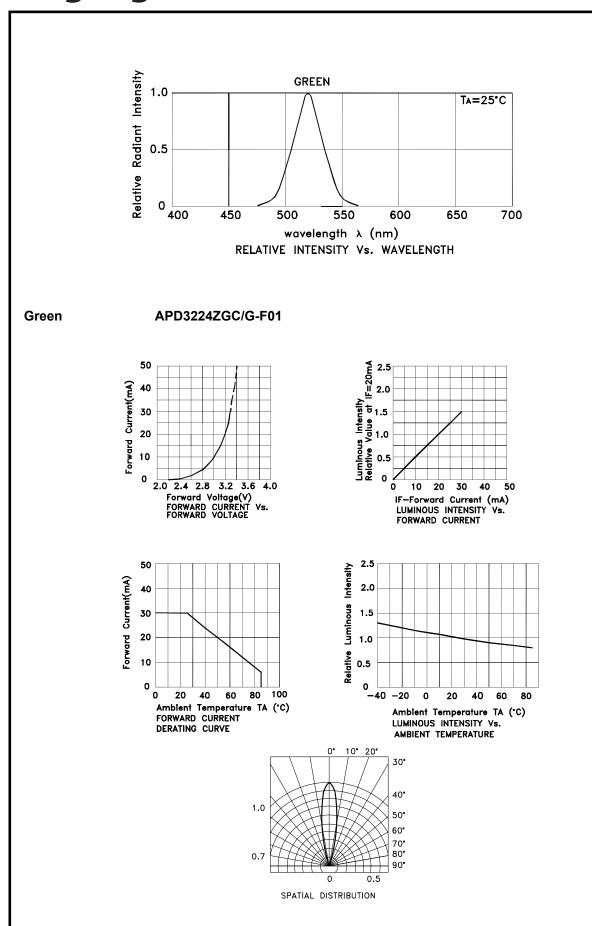
- 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

#### Absolute Maximum Ratings at TA=25°C

| Absolute maximum ratings at 1A 20 0 |                |                |  |  |  |  |
|-------------------------------------|----------------|----------------|--|--|--|--|
| Parameter                           | Green          | Units          |  |  |  |  |
| Power dissipation                   | 120            | mW             |  |  |  |  |
| DC Forward Current                  | 30             | mA             |  |  |  |  |
| Peak Forward Current [1]            | 100            | mA             |  |  |  |  |
| Reverse Voltage                     | 5              | V              |  |  |  |  |
| Operating Temperature               | -40°C To +85°C | -40°C To +85°C |  |  |  |  |
| Storage Temperature                 | -40°C To +85°C |                |  |  |  |  |

Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.

SPEC NO: DSAJ8736 **REV NO: V.1** DATE: OCT/21/2009 PAGE: 2 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: M.L.Xu ERP: 1203009978



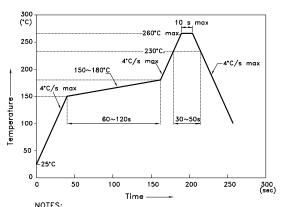
 SPEC NO: DSAJ8736
 REV NO: V.1
 DATE: OCT/21/2009
 PAGE: 3 OF 5

 APPROVED: WYNEC
 CHECKED: Allen Liu
 DRAWN: M.L.Xu
 ERP: 1203009978

#### APD3224ZGC/G-F01

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



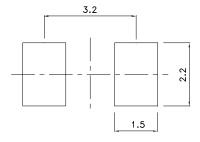
- NOTES:

  1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

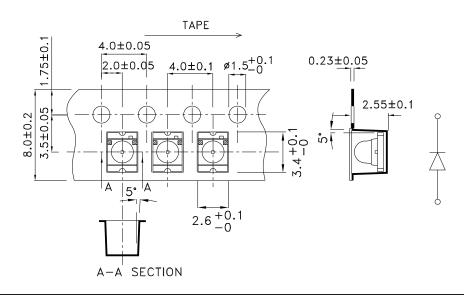
  2.Don't cause stress to the epoxy resin while it is exposed to high temperature. to high temperature.

  3.Number of reflow process shall be 2 times or less.

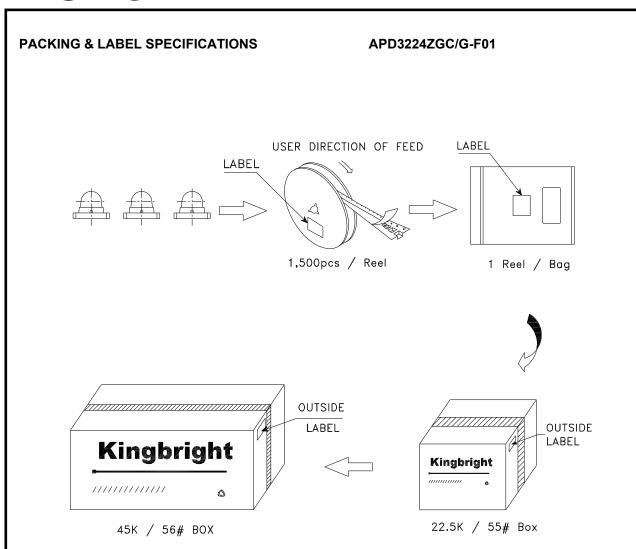
**Recommended Soldering Pattern** (Units: mm; Tolerance: ± 0.1)

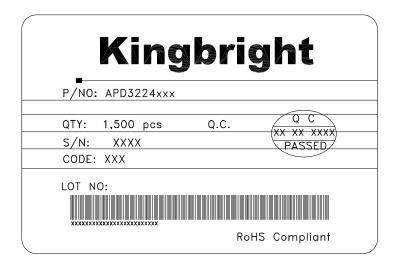


**Tape Dimensions** (Units: mm)



SPEC NO: DSAJ8736 **REV NO: V.1 DATE: OCT/21/2009** PAGE: 4 OF 5 **APPROVED: WYNEC CHECKED: Allen Liu** DRAWN: M.L.Xu ERP: 1203009978





SPEC NO: DSAJ8736 APPROVED: WYNEC REV NO: V.1 CHECKED: Allen Liu DATE: OCT/21/2009 DRAWN: M.L.Xu PAGE: 5 OF 5 ERP: 1203009978